	Top Surface Finish	PbSn	0.020mm			
1	Top Layer	CF-004	0.035mm		GTL	
	Dielectric 1	Core-043	1.499mm	4.3		
2	Bottom Layer	CF-004	0.035mm		GBL	
	Bottom Surface Finish	PbSn	0.020mm			
	Bottom Solder	SM-001	0.025mm	4	GBS	
	Bottom Overlay				GBO	
Total board thickness:			1.659mm			

0.025mm 4

Thickness Constant Gerber Board Layer Stack

GTO

Client Name: Blues Wireless Project Name: Mojo 1.1

Material

SM-001

File: Mojo.PcbDoc

Rev: v4

Layer Name

Top Overlay

Top Solder

## **NOTES:**

## **UNLESS OTHERWISE SPECIFIED:**

- 1. Board Dimension: 25.40mm x 25.40mm
- 2. Total Thickness: 1.6 mm +/- 10%
- 3. Board Material: FR-4, Tg130+
- 4. Copper Layers: 2, Weight: 1 oz5. Soldermask Layers: Both, Color: Black (LPI preferred)
- 6. Legend Layers: Both, Color: White. (LPI preferred)
- 7. Finish: HASL
- 8. Fabricate PCB According to IPC-6012 Class 1
- 9. 1.5 mm (0.06") maximum radius on any inside corner.

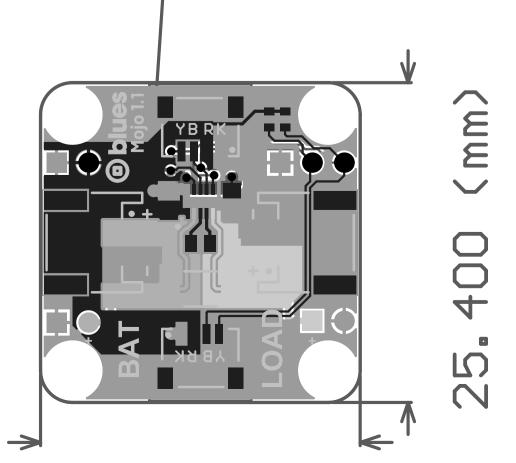
## SPECIAL REQUIREMENTS:

10. A SMD test pad on bottom is normally tented (1 place)

## **VENDOR NOTES:**

- 11. Route board shape and any cut outs per Board Outline layer.
  12. Place added marking (Job Number, Date Code, Mfg ID, etc) on bottom
  13. Boards must pass visual inspection per IPC-A-600 Class 1

Engineering Contact: joseph@toybuilderlabs.com



25.400 (mm)